

## SD2933

### HF/VHF/UHF RF power N-channel MOSFETs

#### Features

- Gold metallization
- Excellent thermal stability
- Common source configuration
- $P_{OUT} = 300 \text{ W min. with } 20 \text{ dB gain @ } 30 \text{ MHz}$
- Thermally enhanced packaging for lower junction temperatures

#### Description

The SD2933 is a gold metallized N-channel MOS field-effect RF power transistor, intended for use in 50 V dc large signal applications up to 150 MHz. Its special low thermal resistance package makes it ideal for ISM applications, where reliability and ruggedness are critical factors.

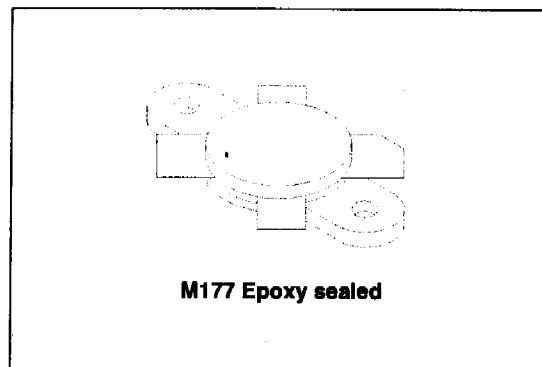
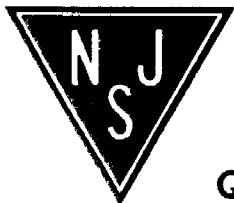
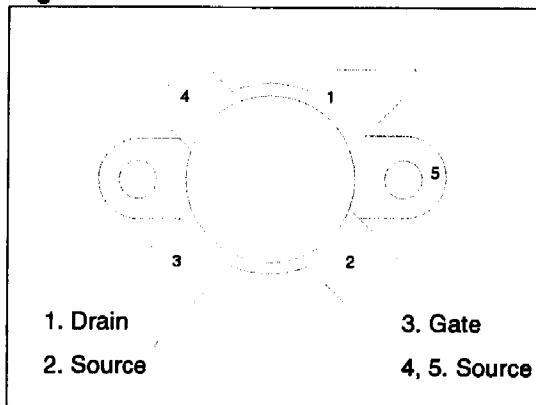


Figure 1. Pin connection



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# 1 Electrical data

## 1.1 Maximum rating

$T_{CASE} = 25^{\circ}C$

**Table 2. Absolute maximum rating**

Symbol	Parameter	Value	Unit
$V_{(BR)DSS}$	Drain source voltage	125	V
$V_{DGR}$	Drain-gate voltage ( $R_{GS} = 1M\Omega$ )	125	V
$V_{GS}$	Gate-source voltage	$\pm 20$	V
$I_D$	Drain current	40	A
$P_{DISS}$	Power dissipation	648	W
$E_{AS}$	Avalanche energy, single pulse ( $I_D = 53 A, 800 \mu H$ coil)	1100	mJ
$T_J$	Max. operating junction temperature	200	$^{\circ}C$
$T_{STG}$	Storage temperature	-65 to +150	$^{\circ}C$

## 1.2 Thermal data

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thJ-C}$	Junction to case thermal resistance	0.27	$^{\circ}C/W$

## Electrical characteristics

$T_{CASE} = 25^{\circ}C$

**Table 4. Static**

Symbol	Test conditions			Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	$V_{GS} = 0 V$	$I_{DS} = 200 mA$		125			V
$I_{DSS}$	$V_{GS} = 0 V$	$V_{DS} = 50 V$				100	$\mu A$
$I_{GSS}$	$V_{GS} = 20 V$	$V_{DS} = 0 V$				500	nA
$V_{GS(Q)}^{(1)}$	$V_{DS} = 10 V$	$I_D = 250 mA$		1.5		4	V
$V_{DS(ON)}$	$V_{GS} = 10 V$	$I_D = 20 A$				3.0	V
$G_{FS}^{(1)}$	$V_{DS} = 10 V$	$I_D = 10 A$		see Table 5: $G_{FS}$ sort			mho
$C_{ISS}$	$V_{GS} = 0 V$	$V_{DS} = 50 V$	$f = 1 MHz$		1000		pF
$C_{OSS}$	$V_{GS} = 0 V$	$V_{DS} = 50 V$	$f = 1 MHz$		372		pF
$C_{RSS}$	$V_{GS} = 0 V$	$V_{DS} = 50 V$	$f = 1 MHz$		29		pF

1.  $V_{GS(Q)}$  and  $G_{FS}$  sorted with alpha/numeric code marked on unit.

**Table 5.  $G_{FS}$  sort**

$G_{FS}$ sort	Value
A	10 - 10.99
B	11 - 11.99
C	12 - 12.99
D	13 - 13.99
E	14 - 14.99
F	15 - 15.99
G	16 - 16.99
H	17 - 18

**Table 6. Dynamic**

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
$P_{OUT}$	$V_{DD} = 50 V$	$I_{DQ} = 250 mA$	$f = 30 MHz$	300	400		W
$G_{PS}$	$V_{DD} = 50 V$	$I_{DQ} = 250 mA$	$P_{OUT} = 300 W$	20	23.5		dB
$\eta_D$	$V_{DD} = 50 V$	$I_{DQ} = 250 mA$	$P_{OUT} = 150 W$	50	65		%
Load Mismatch	$V_{DD} = 50 V$	$I_{DQ} = 250 mA$	$P_{OUT} = 300 W$	3:1			VSWR